

General overview of the ATLAS Upgrade Projects for HL-LHC

Heinz Pernegger (CERN) on behalf of the ATLAS Collaboration

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The ATLAS Upgrade Programme for HL-LHC



- HL-LHC enables a broad physics programme through a 10-fold increase in luminosity starting after Long-shutdown 3 (LS3)
 - recently CERN approved LS3 start with December 2025 and will last 36 months
 - ATLAS just completed its Phase-I upgrade (e.g. New Small Wheel muon detector) and pursues all HL-LHC Phase-II Upgrade projects now in parallel to Run-3 data taking







Challenges for pp-experiments at HL-LHC

- \rightarrow Instantaneous nominal luminosity x 5-7 and integrated luminosity x10
 - New radiation hard sensors complete new tracker
 - Finer sensor granularity
- → Increase of overlapping proton-proton events (pile-up) from $<\mu>$ ~ 50 now to $<\mu>$ ~ 200
 - Additional energy in calorimeters, accumulation of "pile-up" jets especially in the forward region
 - High hit rates of up to 3GHz/cm² in tracker center
- → Increase readout rate 10-fold (L0 trigger rate 1 MHz)
 - requires new front-end and/or back-end electronics for many sub-detectors
 - new DAQ and trigger system to cope with complex high-rate trigger and band-width requirements



Simulated event with ttbar events and average pile-up of 200 collisions per bunch crossing



ATLAS Phase-II Upgrade Projects



- All silicon with at least 9 layers up to |η| = 4
- Less material, finer segmentation

Upgraded Trigger and Data Acquisition System

- Single Level Trigger with 1 MHz output
- Improved 10 kHZ Event Farm

Electronics Upgrades

 On-detector/off-detector electronics upgrades of LAr Calorimeter, Tile Calorimeter & Muon Detectors

Talk by F. Tartarelli: Friday Electronics

Forward detector upgrades

- Luminosity detectors (1% precision)
- HL-ZDC (Heavy Ion physics)

High Granularity Timing Detector (HGTD)

- Precision time reconstruction with Low-Gain Avalanche Detectors (LGAD)
- Improved pile-up separation and bunch-by-bunch luminosity



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rate

sMDTs, and TGCs

Improved trigger efficiency/

momentum resolution, reduced fake

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ITk Tracker Upgrade



ATL-PHYS-PUB-2021-024

- ITk tracker consists of outer strip tracker and inner pixel tracker to replace current ATLAS "Inner Detector"
 - 168 m² of silicon strip and 10 m² of silicon pixel
 - designed to withstand up to $10^{16} n_{eq}/cm^2$ on inner most pixel

• Improve impact parameter resolution and robust tracking

- Coverage increases from $|\eta|{<}2.5$ (ID) to $|\eta|{<}4$ (ITk)
- Provides >9 silicon hits per track
- Reduced material and finer segmentation

• Current status & activities

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- Global ITk support mechanics in production
- CO₂ Cooling studies and optimisation
- Preparation for ITk integration in ATLAS Point 1



Lengths [X₀] Moderator PP1 and enclosure ATLAS Preliminary Dry Nitroger ATLAS mer Patch Panels 0 + 1 Dry Nitrogen Strip services and cooling Simulation ЧШ Simulation Electrical Cabling Strip supports Titanium Cooling Pipes prove Strip modules Support Structure ID Run 2 ITk Lavout : 23-00-03 Radiation Pixel services and cooling Pixel Chips Pixel supports Active Sensors Pixel modules ID Beam pipe and IPT Beam Pipe ITk E Factor

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ITk Pixel Detector Modules

- 5-Layer pixel system with a total of ~ 10000 pixel modules
 - 2-layer inner system replaceable (e.g. after 2ab-1)

ATLAS-TDR-030

- Pixel Front-end chip: Joint development for ATLAS and CMS by RD53 collaboration
 - 50×50 μm^2 pixel size, 153k pixel per FE, pixel module consists of 3 or 4 FE chip
 - Successful prototyping with RD53A and ITKPIXV1 chips
 - Chip yield on after after 50 wafer tested ~ 80%
 - Currently finalise ITKPIXV2 production FE-chip for submission
- Sensors Hybridization Modules
 - 3D sensors with 25×100 μm^2 pixel size in L0 barrel and 50×50 μm^2 pixel size in L0 disks
 - Planar n-in-p detectors of 100 μm (L1) or 150 μm (L2-4) sensor thickness
 - All sensors are in pre-production with most pre-production batches received
 - Hybridization (= bump-bonding) to ITKPIXV1 pre-production modules has started
 - RD53A electrical modules and first ITKPIXV1 electrical modules tested successfully





Ring Triplet Modu



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ITk Pixel Detector Mechanics and System

- Carbon fibre support for pixel modules passed thermal and mechanical qualification
 - first prototype staves & rings are currently loaded with RD53A modules
 - qualify module loading and electrical tests on support mechanics
 - prototype services for electrical readout at 1.28Gbps in hand
- Powering based on serial powering concept
 - chain of up to 13 modules are fed with constant current and chip voltage produced inside FE-chip
 - First two 8-quad module long serial powering chains built and under test









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ITk Strip Detector Modules

• 18000 silicon strip modules

- 2560 or 5120 strips/modules
- developed 3 dedicated ASICs ABCStar (FE), HCCStar (hybrid controller) and , AMACStar (analog monitor/ctrl)
- sensors in production

• Three dedicated ASIC

- ABCStar extensively SEE tested in heavy-ion and proton beams production order placed
- HCCStar andAMACStar pre-production delivered and currently under test

• Sensors in production

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- Hybrid and modules in preproduction
 - performance and yield as expected







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ITk Strip Detector Barrel and Endcaps

Strong progress in modules & mechanics

- First electrical petal complete (13 hybrid, 9 module types)
- Irradiated short-strip modules with production ABCStar had wide operating window after 150% maximum fluence
- Local mechanics also in pre-production
 - Endcap petal cores assembled successfully in industry
- Global mechanics are in production
 - Most elements nearing completion in end-cap







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High-Granularity Timing Detector

- New HGTD detector to resolve pile-up through hit timing information
 - installed between ITK and FC calorimeter 2.4<|η|<4.0
 - 4 layer of LGAD to achieve 30ps-50ps timing resolution (70ps per hit)
 - also provides bunchby-bunch luminosity measurement

HGTD modules

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- LGAD sensor with 1.3x1.3 mm² pixel size
- bump-bonded to FE-ASIC ALTIROC



Pileup Jet rejection with and with out HGTD





High-Granularity Timing Detector

Present status sensors & modules

- first hybrids with ALTIROC2 FE chip and FE-chip functionality demonstrated
- Carbon infused sensors more robust against Single Event Burn-out (SEB) with stable operation at lower voltages

Services and mechanics

 construct thermal demonstrator to qualify cooling and mechanics support



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https://twiki.cern.ch/twiki/bin/view/AtlasPublic/HGTDPublicPlots



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LAr calorimeter: Upgrade Front-end and readout

Phase-II



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LAr calorimeter Upgraded Front-end and readout

- Need linearity ~0.1% up to 300 GeV (for precision physics, e.g. Higgs and W mass), electronics noise < MIP (for calibration), minimal saturation for large signals => 16-bit dynamic range with 11-bit precision (implemented in 2 overlapping 14-bit gains)
- Four LAr-specific ASICs:
 - Preamp[pre-shaper for HEC]/shaper
 - ADC
 - Calibration DAC and pulser
- Transmit data off-detector at 40 MHz
 - 225 Gbps/board: lpGBT + VL+ chipset
 - (345 Tbps full calorimeter)
- Filter digital waveform to extract energy and time
 - LAr Calorimeter timing resolution ~200 ps!
 - High-end FPGAs on ATCA boards, ~33k inputs at 10 Gbps
- Transmit data to L0 trigger and DAQ
 - 25 Gbps links





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ADC prototype (65 nm CMOS): octal, 15 bit, 11+ ENOB



ATCA Test Board: 2 STRATIX 10, 24 Fireflies





Hadron Calorimeter (Tile) Upgrade electronics





- Modified mechanics for easier access/maintainability
- Fully digital readout data and input to trigger system
- Replacement of 10% of the PMTs
- · Most on-detector items are in pre-production
 - Daughter board prototype evaluation nearly complete
 - Mini-Drawer Mechanics well into production
- Pre-production electronics operated together at SPS testbeam
 - And performs as expected

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Off-detector electronics prototype under evaluation



Tile Phase-II demonstrator (tested in test beams)





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Muon Detector and Electronics upgrade





- Upgrade readout/trigger electronics
 - all hit data is sent off detector to trigger logic boards with L0 trigger rate of 1MHz
- Addition layers of sMDT, RPC, and TGC to
 - improve coverage, trigger uniformity & momentum resolution, reduce fake rates
- Current status

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- <u>sMDT:</u> chambers in production, electronics near pre-production
- <u>RPC:</u> FE prototypes submitted, prototype chamber nearly complete
- <u>TGC</u>: Triplet prototype completed, FE ASIC production complete





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Forward Detector system





- Stable and precise luminosity measurement in forward direction
 - BCM': diamond based beam conditions monitor to monitor beam and provide bunch-bybunch luminosity measurement (inside ITk)
 - HGTD also provides bunch-bybunch luminosity measurement
 - PLR: Pixel luminosity rings based on silicon pixel detector (inside lnk volume)
 - New LUCID3: Cherenkov integrating luminosity monitor based on Cherenkov hit counting in new location
- Heavy Ion Physics programme

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 New Zero-Degree-Calorimeter (ZDC) in development for HL-LHC Run 4



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DAQ and Trigger upgrade for HL-LHC

- Move to 1 MHz single-level HW trigger for all systems
 - Level 0: 1 MHz, ~5.2 TB/s, latency 10 μs
 - Event Farm: 10 kHz, ~52 GB/s
- Exploit full detector granularity and extended tracking range, improve muon trigger efficiency
- FE electronics linked via FELIX readout to DAQ
- Prototypes of FELIX, jFEX, L0Muon Trigger, & Global Trigger under evaluation



L0 muon trigger prototype

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FELIX Phase-II prototype



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ATLAS Upgrade presentations and poster

- Laura Gonella : Solid State Detector session on Tuesday The ATLAS ITk Detector System for the Phase-II LHC Upgrade
- Francesco Tartarelli : Electronics session on Friday ATLAS toward the High Luminosity era: challenges on electronic systems
- Daniela Bortoletto : Detector Systems poster Expected tracking and readout performance of the ATLAS Phase-II Inner Tracker Upgrade
- Nicolas Viaux : Detector Systems poster The ATLAS New Small Wheel new Muon Stations Ready for LHC Run3
- Tobias Bisanz : Detector Systems poster Operational Experience and Performance with the ATLAS Pixel detector at the Large Hadron Collider
- Federico Lasagni Manghi : Detector Systems poster The upgrade of the ATLAS Luminosity detector (LUCID) for HL-HLC
- · Maciej Trzebinski : Solid State Detector poster Overview of ATLAS forward proton detectors for LHC Run 3 and plans for the HL-LHC
- Marianna Testa : Solid State Detector poster Expected reconstruction performance with the new ATLAS Inner Tracker at the High-Luminosity LHC
- Jiri Kroll : Solid State Detector poster Effect of irradiation and annealing performed with bias voltage applied across the coupling capacitors on the interstrip resistance of ATLAS ITk
- Vera Letonova : Solid State Detector poster Characterization of the polysilicon resistor in silicon strip sensors for ATLAS Inner Tracker as a function of temperature, pre- and post-irradiation
- · Abhishek Sharma : Solid State Detector poster Module development for the ATLAS Phase II Pixel Inner Tracker
- David Rousso : Solid State Detector poster Test and extraction methods for the QC parameters of silicon strip sensors for ATLAS upgrade tracker
- Punit Sharma : Solid State Detector poster Electrical performances of pre-productions staves for the ATLAS ITk Strip Detector Upgrade
- · Nicola Pacifico : Solid State Detector poster An environmental monitoring and control system for the ATLAS Outer Barrel QC and Integration
- Javier Fernandez-Tejero : Solid State Detector poster Analysis of humidity sensitivity of silicon strip sensors for ATLAS upgrade tracker, pre- and post-irradiation
- Matthew Addison : Solid State Detector poster The development of high precision, fast-timing 3D silicon sensors with a focus on the high luminosity upgrades of the ATLAS detector
- Tingyu Zhang : Calorimetry poster ATLAS LAr Calorimeter Commissioning for LHC Run-3
- Antonio Jesus Gomez Delegido : Calorimetry poster Upgrade of ATLAS Hadronic Tile Calorimeter for the High Luminosity LHC
- · Giorgio Chiarelli: : Calorimetry poster Long term aging test of the new PMTs for the HL-LHC ATLAS hadron calorimeter upgrade
- Nina Wenke: : Calorimetry poster Performance studies of single-particles uncertainties and Local Hadron Calibration for Particle-Flow jets in ATLAS
- Kristina Mihule: : Calorimetry poster Time calibration, monitoring and performance of the ATLAS Tile Calorimeter in Run 2
- · Giorgio Chiarellic: Calorimetry poster Long term aging test of the new PMTs for the HL-LHC ATLAS hadron calorimeter upgrade
- Kevin Nelson : Gas detector poster Construction and testing of the sMDT system for the HL-LHC ATLAS muon detector upgrade
- Robert Faure : Trigger/DAQ poster Machine Learning for Real-Time Processing of ATLAS Liquid Argon Calorimeter Signals with FPGAs
- Liangliang Han : Trigger/DAQ poster Demonstration System of the HGTD Peripheral Electronics Board (PEB) for ATLAS Phase II Upgrade
- Davide Cieric: Trigger/DAQ poster Upgrade of the first-level muon trigger for the ATLAS experiment at the HL-LHC
- Damir Raßloff : Trigger/DAQ poster The phase-1 upgrade of the ATLAS level-1 calorimeter trigger
- Antonio Cervello Duato : Trigger/DAQ poster The TileCal PreProcessor Interface with the ATLAS Global Data Acquisition System at the HL-LHC
- Mengging Wu: Trigger/DAQ poster FELIX: readout upgrade for the ATLAS Trigger DAQ system in HL-LHC
- Will Kalderon: Trigger/DAQ poster FPGA-based techniques to improve fast track finding in the ATLAS Trigger
- Will Kalderon: Trigger/DAQ poster The ATLAS Forward Proton Real-Time Time-of-Flight Trigger and Trigger Decoder for LHC Run 3
- Jan Zich: Trigger/DAQ poster FPGA-based techniques to improve fast track finding in the ATLAS Trigger

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Summary

- ATLAS currently develops and constructs major upgrades to its detector system to optimise the experiment for HL-LHC data taking
- An all-new silicon tracker (ITk) with 5 layer pixel and 4 layer strips improves tracking up to $|\eta|{<}4$
- The High Granularity Timing Detector (HGTD) based on LGADs will help to resolve pile-up through timing measurements
- Additional muon detector upgrade will follow the LS2 New small wheel installation
- Most detector electronics, DAQ and trigger systems will be upgrades to cope with the luminosity increased and increased trigger/readout rate



